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| Substitute for form 1449/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Use as many sheets as necessary)</i> | | | | Complete If Known | |
| | | | | Application Number | 10/733,226-Conf. #8010 |
| | | | | Filing Date | December 10, 2003 |
| | | | | First Named Inventor | William M. Hiatt |
| | | | | Art Unit | 2811 |
| | | | | Examiner Name | C. A. Matthews |
| Sheet | 1 | of | 12 | Attorney Docket Number | 108298744US |

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